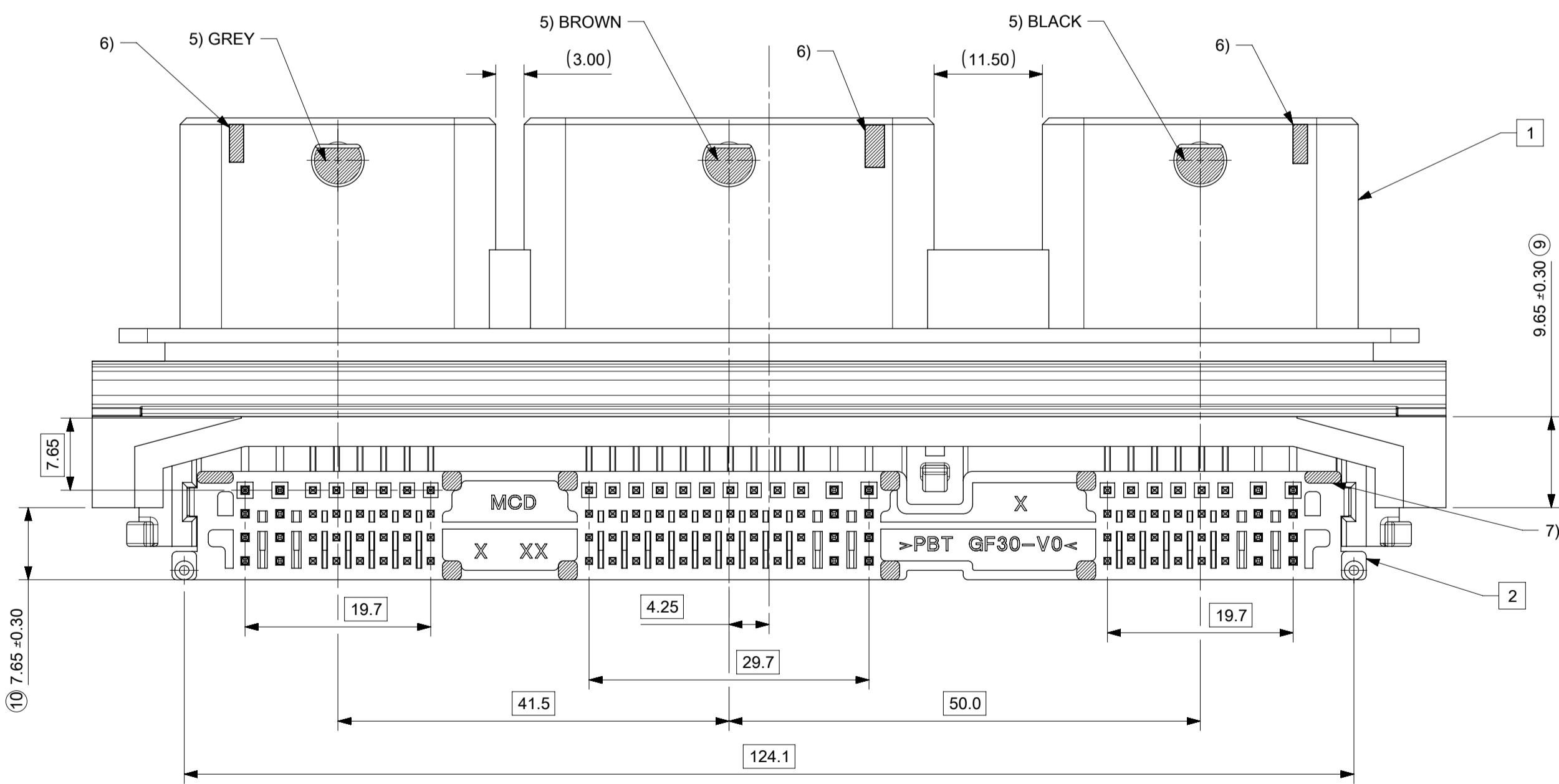
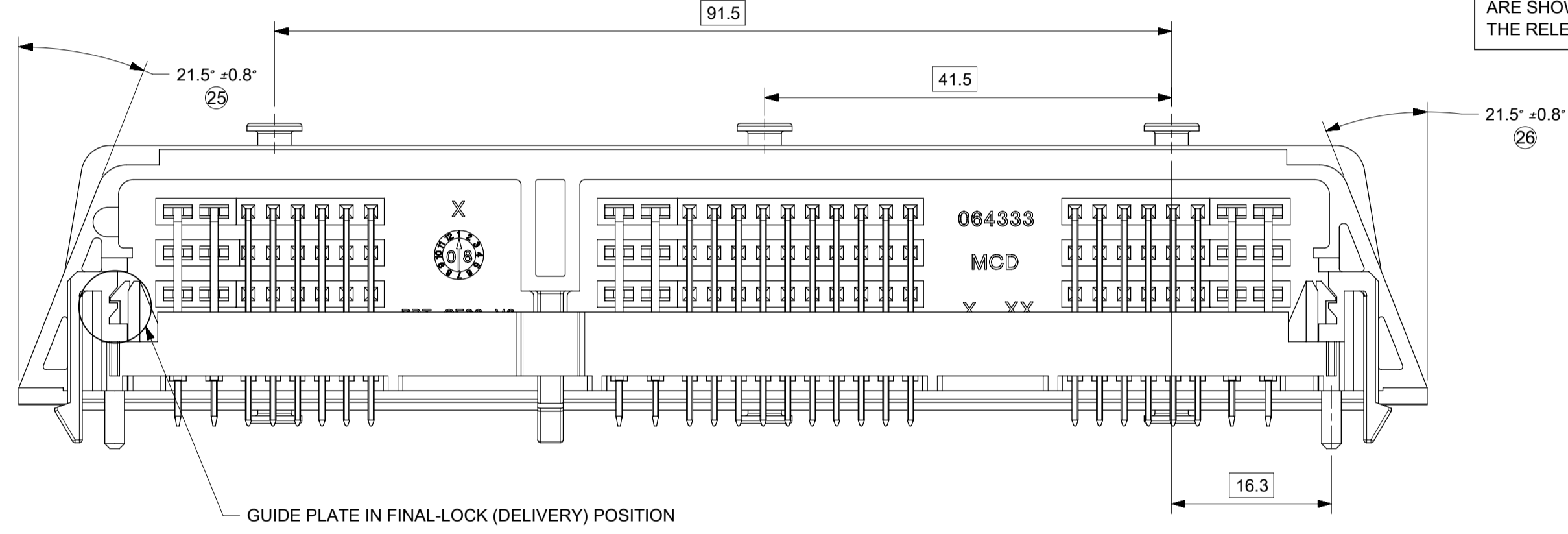
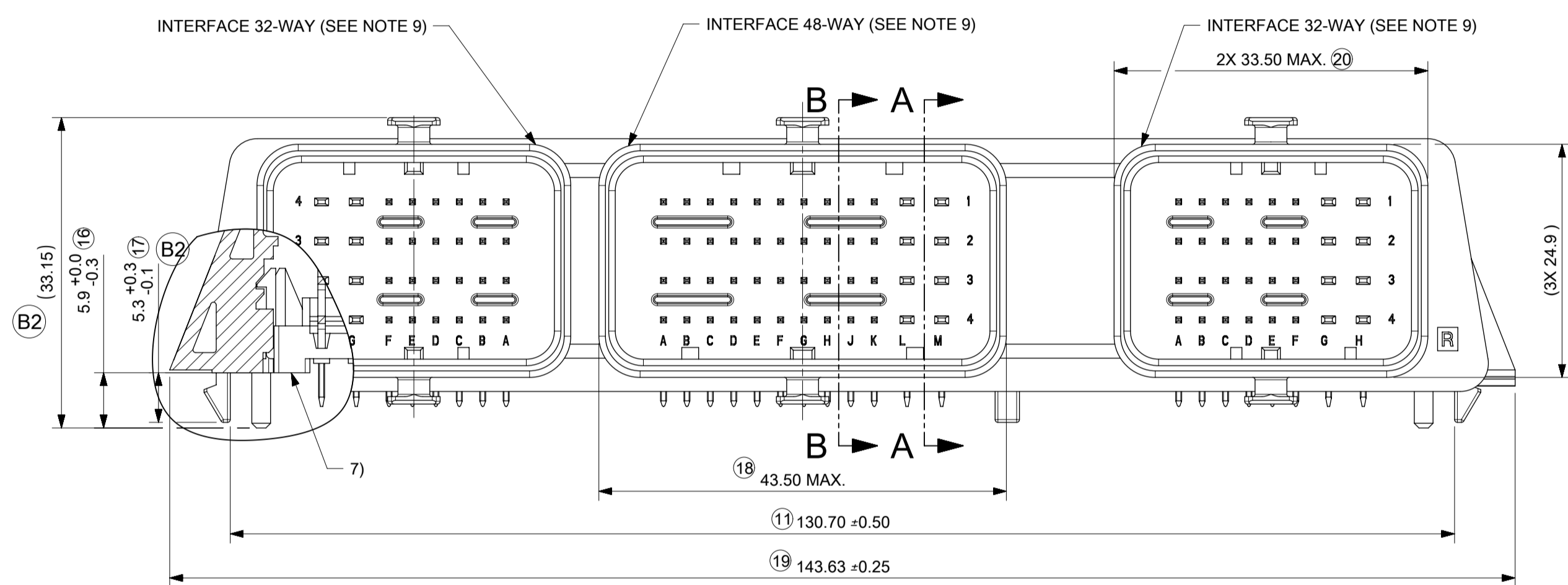


TECHNICAL PERFORMANCE CHARACTERISTICS		
LOCKING FEATURES RETENTION FORCE AVERAGE: >260N THE LOWEST RETENTION FORCE VALUE >240N		
PIN RETENTION AND TRACTION FORCES:		
PIN AND TAB RETENTION AND TRACTION FORCES:		
PIN	SIZE	RETENTION FORCES
PIN 0.635	0.635 x 0.635	30N
PIN 1.5	1.5 x 0.8	60N
SOLDERABILITY: TESTING ACC. DIN IEC 60068-2-20 WITHOUT PRE-AGING		
ALL FEATURE TECHNICAL PERFORMANCE CHARACTERISTICS ARE SHOWN IN PRODUCTS AND TEST SPECIFICATION OF THE RELEVANT FEMALE CONNECTORS -> PS-64319-001		



- NOTES**
- 1 - GENERAL TOLERANCE ACC. DIN 16901 GROUP 130
 - 2 - SEALING AREA (NO BURR, SCRATCHES, CONTAMINATION, SHRINK DEPENDED WARPAGE AND TOOL SPLITTING LINES ALLOWED)
 - 3 - MATERIAL MARKING
ADDITIONAL MARKING POSSIBLE
e.g.: - CAVITY NO.
- MATERIAL NO.
- VERSION NO.
- TRACEABILITY MARKING (INK-JET OR LASERMARKING (SPECIAL PLASTIC MATERIAL NEEDED))
- etc.
 - 4 - TOOLING SPLITTING LINES FOR AIR VENT (2X)
 - 5 - COLOUR CODING ON INTERFACE
 - 6 - MARKING FOR HARNESS DIRECTION: APPLY THERMAL RIBBON
 - 7 - PCB SUPPORT SURFACE (10X)
 - 8 - MATES WITH CMC CONNECTOR 48CKT AND 32CKT
MATERIAL NUMBERS:
LEFT WIRE OUTPUT GREY CODING 643191218
RIGHT WIRE OUTPUT BROWN CODING 643203319
RIGHT WIRE OUTPUT BLACK CODING 643193211
 - 9 - THE PRODUCT INTERFACE DRAWING INFORMATION, SEE SD-98644-006

B2	628872	1. UPDATED VIEWS FROM GUIDE PLATE PRE-LOCK TO FINAL LOCK 2. UPDATED DIM 17 FROM BASIC 3.2 TO 5.3 DUE TO GUIDE PLATE POSITION CHANGE 3. REMOVED BALLOON NUMBER FOR BASIC DIMENSIONS 4. UPDATED NOTES 6 FROM WHITE INK TO THERMAL RIBBON 5. REMOVED GERMAN LANGUAGE 6. REMOVED INTERFACE DRAWING APPENDED ON SHEET 3 TO SHEET 5 7. ADDED INSPECTION BALLOON NUMBER LOG 8. NX RE-MASTERING
B1	GCA2011-0027	UPDATE DESCRIPTION FOR SOLDERABILITY TEST
B	GCA2011-0002	UPDATE INTERFACE DRAWING ACCORDING TO SD-98644-006 REV.B
A1	GCA2009-0060	INITIAL RELEASE
REV.	EC#	DESCRIPTION

INSPECTION BALLOON NUMBER LOG	
PER DRAWING REVISION: B1	
LAST BALLOON NUMBER USED: 33	
ADDED BALLOON NUMBER USED:	
REMOVED BALLOON NUMBER: 1-8, 27, 28, 29, 40	

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

DIMENSION UNITS	SCALE	CURRENT REV DESC: REFER TO REVISION CHANGE LOG FOR DETAIL IN C-4 OF SHEET 1
mm	2:1	
GENERAL TOLERANCES (UNLESS SPECIFIED)		
ANGULAR TOL	± °	
4 PLACES	±	
3 PLACES	±	
2 PLACES	±	
1 PLACE	±	
0 PLACES	±	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	THIRD ANGLE PROJECTION	DRAWING SERIES
		A1-SIZE 64333
		MATERIAL NUMBER CUSTOMER SHEET NUMBER
		SEE TABLE GENERAL MARKET 1 OF 2

molex

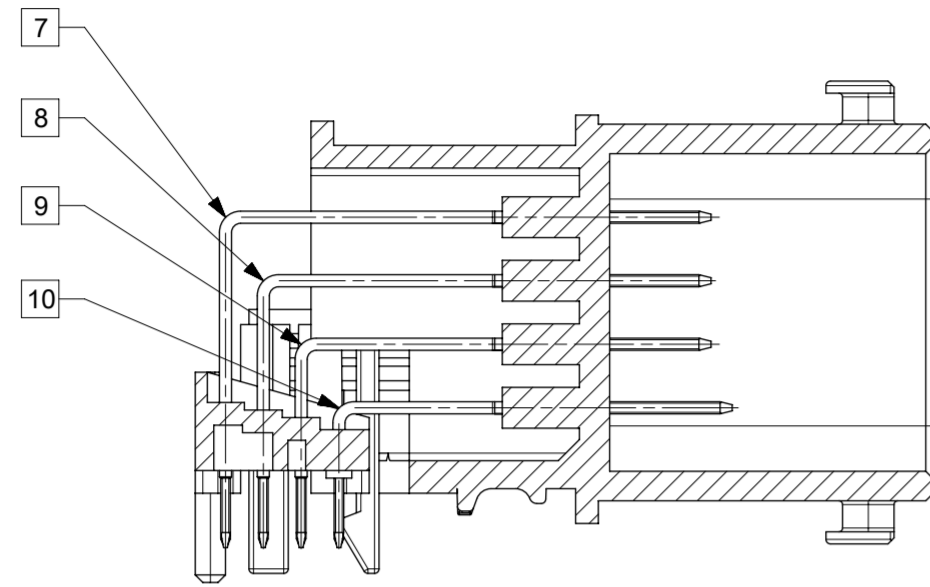
CMC HEADER 112CKT
ASSEMBLED SOLDER VERSION

PRODUCT CUSTOMER DRAWING

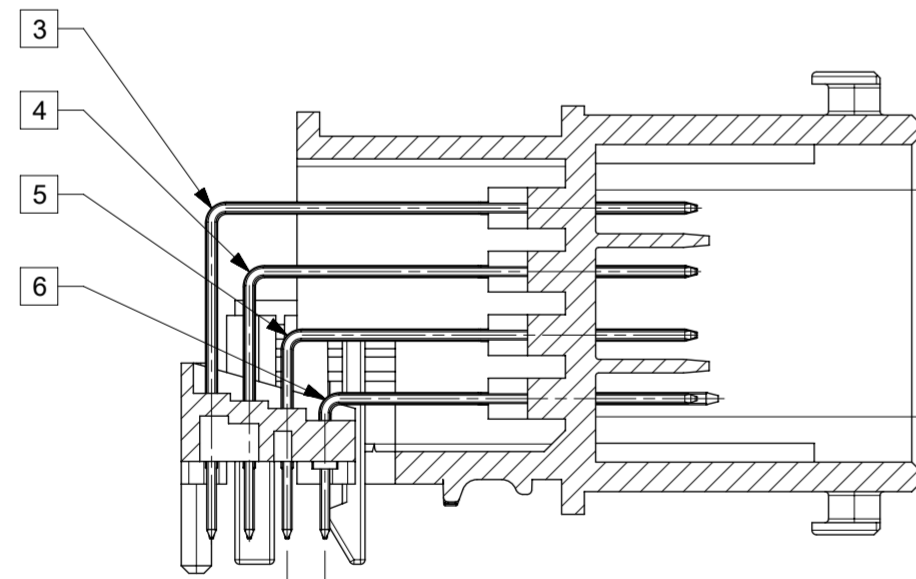
DOCUMENT NUMBER: SD-64333-100
DOC TYPE: PSD
DOC PART: 005
REVISION: B2

ITEM	DESCRIPTION	MOLEX P/N	RAW MATERIAL	BARRIER (OVERALL)	FINISH (OVERALL)	PLATING (µm)	UNIT	AMOUNT
10	PIN 1.5 ROW 4	500756-4024	CuZn30 R410	Ni 1.3-3.8	Sn 2-4	PC	6	6
9	PIN 1.5 ROW 3	500756-3024	CuZn30 R410	Ni 1.3-3.8	Sn 2-4	PC	6	6
8	PIN 1.5 ROW 2	500756-2024	CuZn30 R410	Ni 1.3-3.8	Sn 2-4	PC	6	6
7	PIN 1.5 ROW 1	500756-1024	CuZn30 R410	Ni 1.3-3.8	Sn 2-4	PC	6	6
6	PIN 0.64 ROW 4	500757-4024	CuZn30 R410	Ni 1.3-3.8	Sn 2-4	PC	22	22
5	PIN 0.64 ROW 3	500757-3024	CuZn30 R410	Ni 1.3-3.8	Sn 2-4	PC	22	22
4	PIN 0.64 ROW 2	500757-2024	CuZn30 R410	Ni 1.3-3.8	Sn 2-4	PC	22	22
3	PIN 0.64 ROW 1	500757-1024	CuZn30 R410	Ni 1.3-3.8	Sn 2-4	PC	22	22
2	GUIDE PLATE	0643330002	PBT GF30-V0 BLK	---	---	PC	1	1
1	HOUSING	0643330010	PBT GF30-V0 BLK	---	---	PC	1	1

DOCUMENT STATUS	P1	RELEASE DATE	2020/02/19 14:34:51
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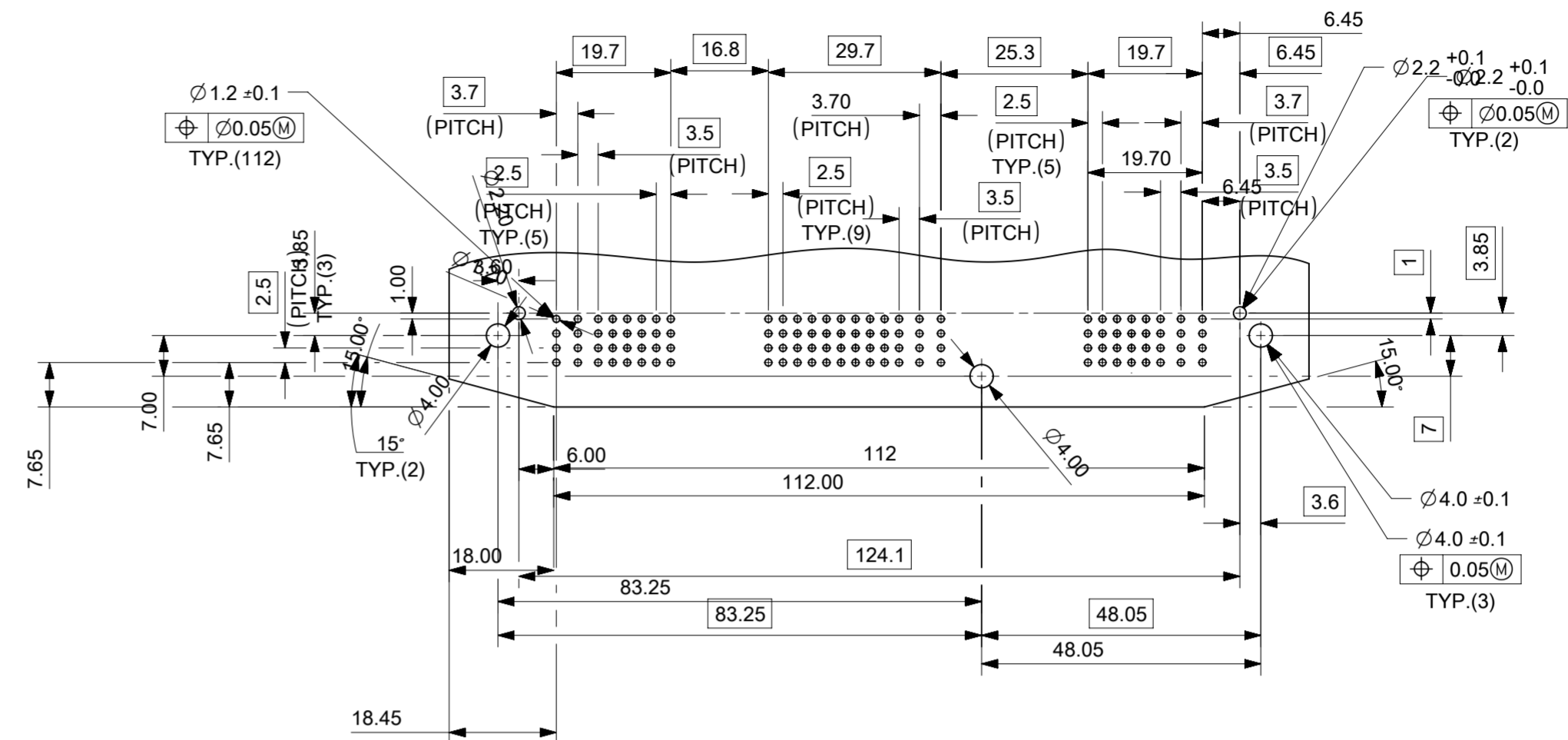


SECTION A-A



PITCH FROM ROW TO ROW

SECTION B-B



RECOMMENDED PCB LAYOUT (COMPONENT SIDE)
THICKNESS: 1.6±0.1mm

NOTES:

1. THE VIEW "RECOMMENDED PCB LAYOUT" SHOWS THE SECTION OF THE HOLE POSITION CONCERNING THE HEADER-PIN, GUIDING AND LOCKING LAYOUT.
2. THE VIEW OF THE HOLE PATTERN DOESN'T POINT TO THE ABSOLUTE POSITION ON THE PCB.
3. THE HOLE PATTERN IS COPY OF THE HEADER LAYOUT.
4. PLEASE COMBINE THE TWO ELEMENTS (HEADER AND VIEW OF THE HOLE PATTERN) TO CREATE PCB LAYOUT

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

DIMENSION UNITS mm	SCALE 1:1	CURRENT REV DESC: REFER TO REVISION CHANGE LOG FOR DETAIL IN C-4 OF SHEET 1				
GENERAL TOLERANCES (UNLESS SPECIFIED)		EC NO: 628872				
ANGULAR TOL ± °		DRWN: HKANG03 2019/12/14	PRODUCT CUSTOMER DRAWING			
4 PLACES ±		CHK'D: HWBAI 2020/02/19	DOCUMENT NUMBER			
3 PLACES ±		APPR: SLAFAURE 2020/02/19	SD-64333-100			
2 PLACES ±		INITIAL REVISION:	DOC TYPE	DOC PART	REVISION	
1 PLACE ±		DRWN: TLUO 2009/07/02	PSD	005	B2	
0 PLACES ±		APPR: GGLEE 2009/07/07				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	THIRD ANGLE PROJECTION	DRAWING A2-SIZE	SERIES 64333	MATERIAL NUMBER SEE TABLE	CUSTOMER GENERAL MARKET	SHEET NUMBER 2 OF 2